

**AMENDMENTS TO THE CLAIMS, COMPLETE LISTING OF CLAIMS
IN ASCENDING ORDER WITH STATUS INDICATOR**

Please amend the claims as follows.

1. (Currently Amended) A conductive particle comprising: ~~of which the surface of a base particle; core materials disposed on the surface of the base particle; and is covered with a conductive film or conductive films and which has projections formed by projecting of said conductive film or conductive films, wherein a core material for projecting the surface of said conductive film is provided on covering the surface of said base particle and said core material materials;~~
~~wherein projections are formed on the outer surface of the conductive film or conductive films; and~~
~~wherein the core materials is are composed of a conductive material different from a conductive material composing said conductive film or conductive films.~~
2. (Currently Amended) The conductive particle according to claim 1, wherein each of said core material materials has a shape in lump form.
3. (Currently Amended) The conductive particle according to claim 1 or 2, wherein the outermost surface of said conductive film is a gold layer.
4. (Currently Amended) A conductive particle comprising: ~~a base particle; wherein said conductive particle has a core materials material in particle form, composed of a conductive material, disposed on the surface of a the base particle and made of a conductive material; and,~~
~~a plated coat covering the surface of said base particle and said core material materials; are covered with a plated coat and said conductive particle has~~

~~wherein projections are formed by projecting of on the outer surface of said plated coat by thus covering said core material.~~

5. (Currently Amended) The conductive particle according to claim 4, wherein at least 80% or more of said core ~~materials~~-material existing on the surface of said base particle contacts with said base particle or exists within a range of 5 nm from said base particle.

6. (Currently Amended) The conductive particle according to claim 4 or 5, wherein the outermost surface of said plated coat is a gold layer.

7. (Currently Amended) The conductive particle according to claim 1 or 4, wherein said core ~~materials~~-material is are composed of at least one or more species of metal.

8. (Currently Amended) The conductive particle according to claim 1 or 4, wherein said base particle is a resin particle.

9. (Currently Amended) The conductive particle according to claim 1 or 4, wherein an average height of said ~~projections~~-projection portions projecting is 0.5% or more of an average particle diameter of the ~~said~~ conductive particle particles.

10. (Currently Amended) An anisotropic conductive material comprising a resin binder and, wherein the conductive particle particles according to claim 1 or 4-are dispersed in-a said resin binder.